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### What is "[Embedded - Microcontrollers](#)"?

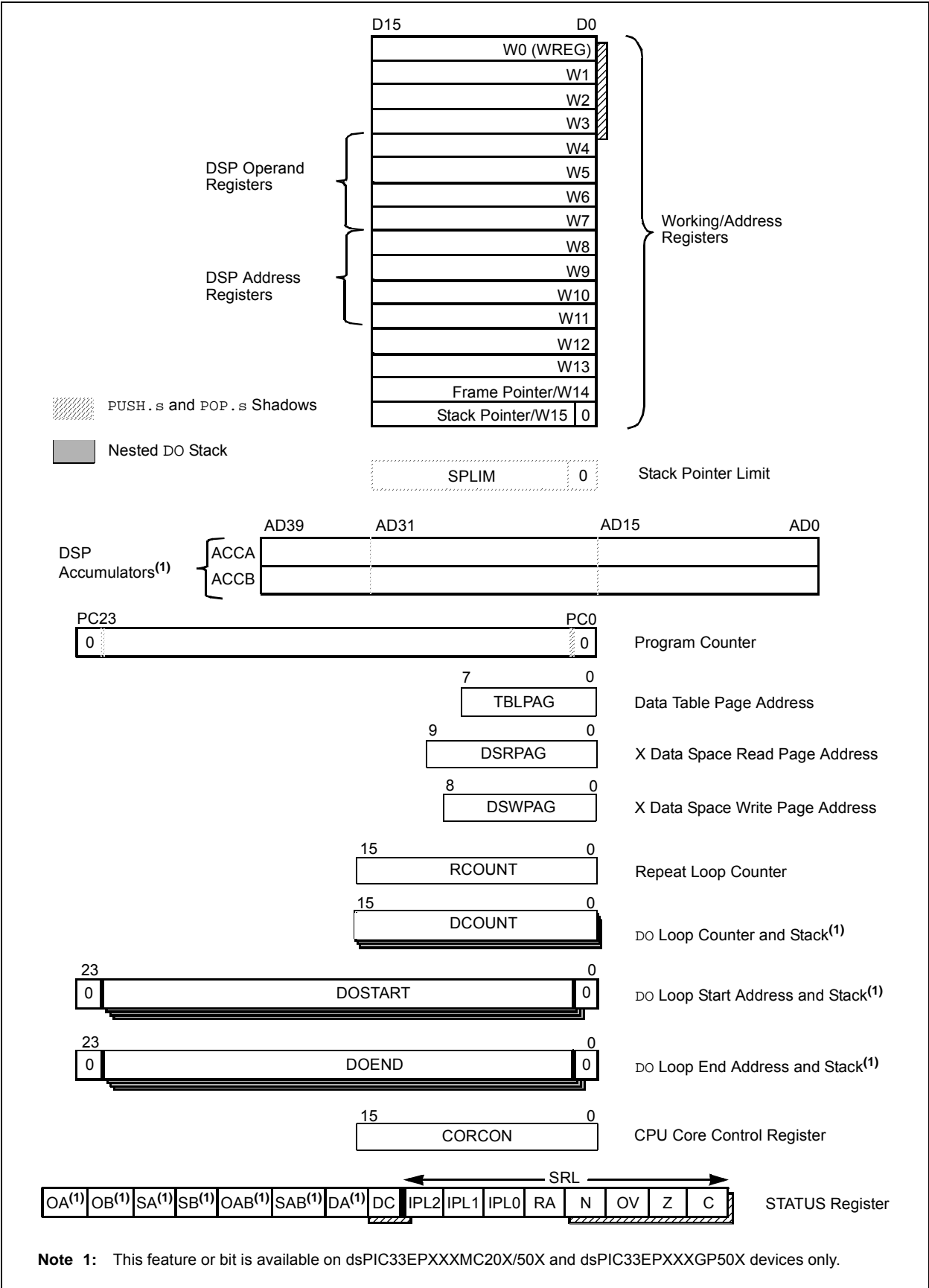
"[Embedded - Microcontrollers](#)" refer to small, integrated circuits designed to perform specific tasks within larger systems. These microcontrollers are essentially compact computers on a single chip, containing a processor core, memory, and programmable input/output peripherals. They are called "embedded" because they are embedded within electronic devices to control various functions, rather than serving as standalone computers. Microcontrollers are crucial in modern electronics, providing the intelligence and control needed for a wide range of applications.

### Applications of "[Embedded - Microcontrollers](#)"

#### Details

Product Status	Obsolete
Core Processor	PIC
Core Size	16-Bit
Speed	70 MIPS
Connectivity	I <sup>2</sup> C, IrDA, LINbus, QEI, SPI, UART/USART
Peripherals	Brown-out Detect/Reset, DMA, Motor Control PWM, POR, PWM, WDT
Number of I/O	35
Program Memory Size	256KB (85.5K x 24)
Program Memory Type	FLASH
EEPROM Size	-
RAM Size	16K x 16
Voltage - Supply (Vcc/Vdd)	3V ~ 3.6V
Data Converters	A/D 9x10b/12b
Oscillator Type	Internal
Operating Temperature	-40°C ~ 85°C (TA)
Mounting Type	Surface Mount
Package / Case	44-VFTLA Exposed Pad
Supplier Device Package	44-VTLA (6x6)
Purchase URL	<a href="https://www.e-xfl.com/product-detail/microchip-technology/pic24ep256mc204t-i-tl">https://www.e-xfl.com/product-detail/microchip-technology/pic24ep256mc204t-i-tl</a>

FIGURE 3-2: PROGRAMMER'S MODEL



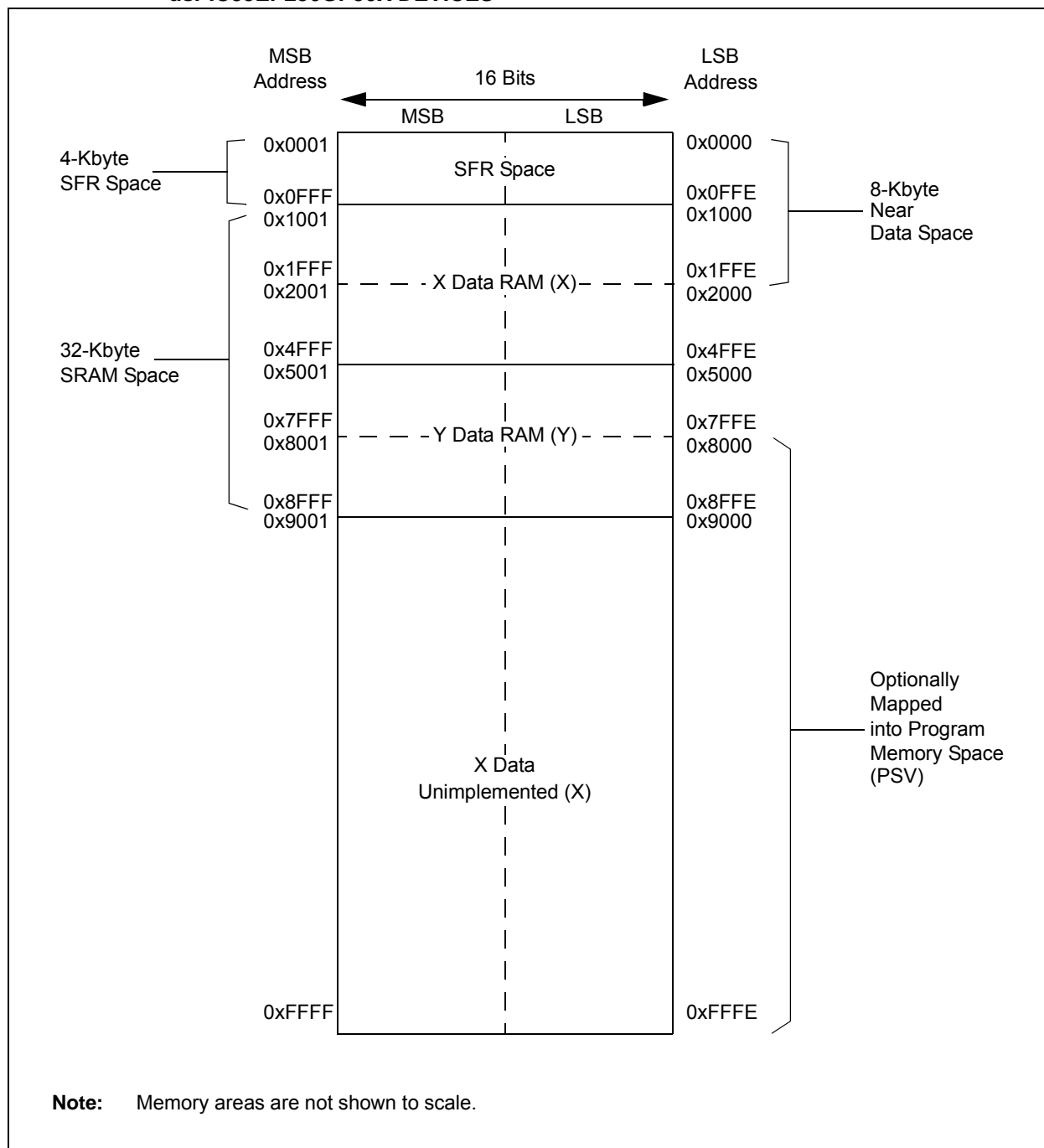
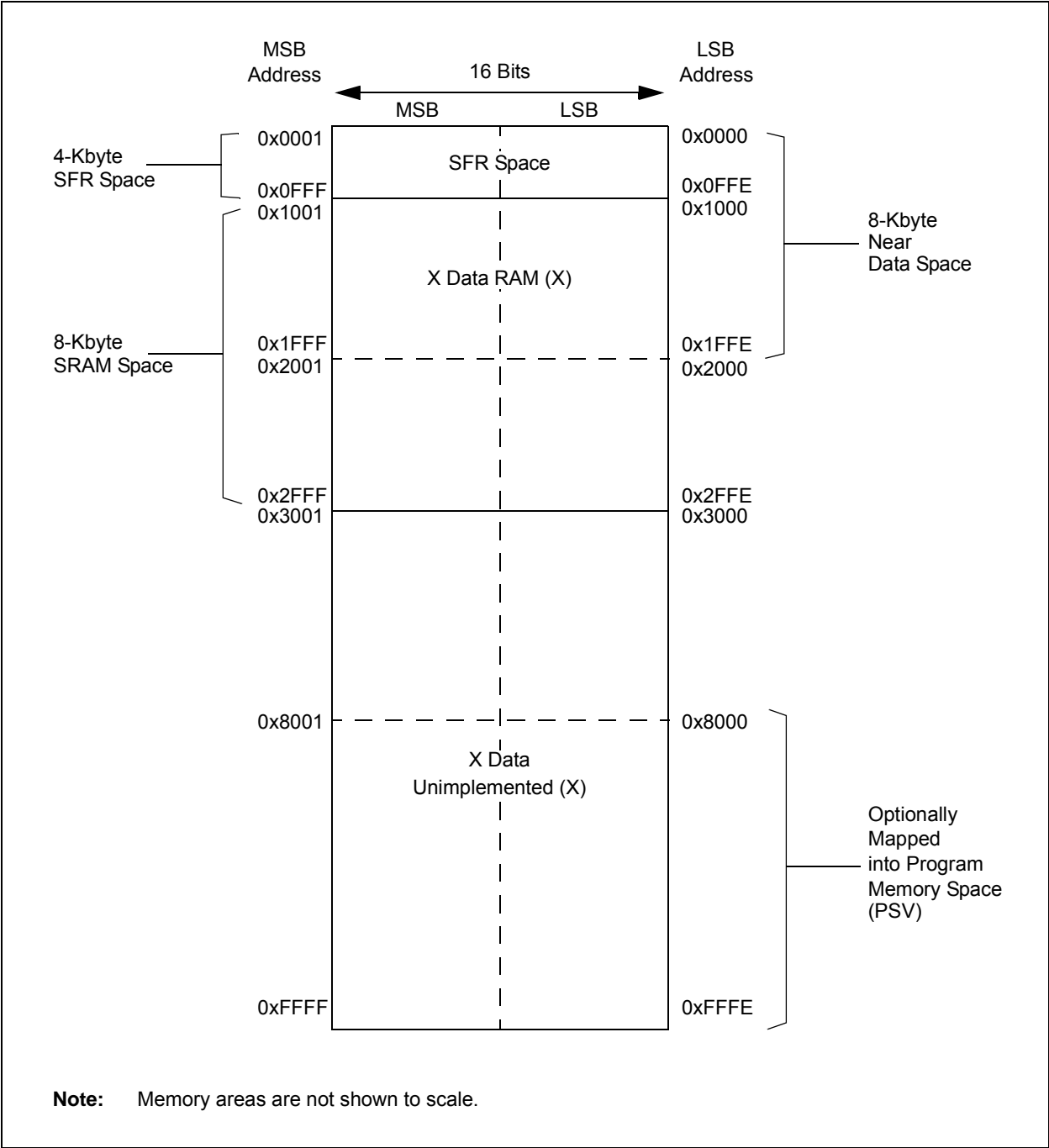
**FIGURE 4-10: DATA MEMORY MAP FOR dsPIC33EP256MC20X/50X AND dsPIC33EP256GP50X DEVICES**

FIGURE 4-13: DATA MEMORY MAP FOR PIC24EP64GP/MC20X/50X DEVICES



**TABLE 4-31: PERIPHERAL PIN SELECT INPUT REGISTER MAP FOR dsPIC33EPXXXGP50X DEVICES ONLY**

File Name	Addr.	Bit 15	Bit 14	Bit 13	Bit 12	Bit 11	Bit 10	Bit 9	Bit 8	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	All Resets		
RPINR0	06A0	—	INT1R<6:0>								—	—	—	—	—	—	—	—	0000	
RPINR1	06A2	—	—	—	—	—	—	—	—	—	INT2R<6:0>								0000	
RPINR3	06A6	—	—	—	—	—	—	—	—	—	T2CKR<6:0>								0000	
RPINR7	06AE	—	IC2R<6:0>								—	IC1R<6:0>								0000
RPINR8	06B0	—	IC4R<6:0>								—	IC3R<6:0>								0000
RPINR11	06B6	—	—	—	—	—	—	—	—	—	OCFAR<6:0>								0000	
RPINR18	06C4	—	—	—	—	—	—	—	—	—	U1RXR<6:0>								0000	
RPINR19	06C6	—	—	—	—	—	—	—	—	—	U2RXR<6:0>								0000	
RPINR22	06CC	—	SCK2INR<6:0>								—	SDI2R<6:0>								0000
RPINR23	06CE	—	—	—	—	—	—	—	—	—	SS2R<6:0>								0000	
RPINR26	06D4	—	—	—	—	—	—	—	—	—	C1RXR<6:0>								0000	

**Legend:** — = unimplemented, read as '0'. Reset values are shown in hexadecimal.

**TABLE 4-32: PERIPHERAL PIN SELECT INPUT REGISTER MAP FOR dsPIC33EPXXXMC50X DEVICES ONLY**

File Name	Addr.	Bit 15	Bit 14	Bit 13	Bit 12	Bit 11	Bit 10	Bit 9	Bit 8	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	All Resets		
RPINR0	06A0	—	INT1R<6:0>								—	—	—	—	—	—	—	—	0000	
RPINR1	06A2	—	—	—	—	—	—	—	—	—	INT2R<6:0>								0000	
RPINR3	06A6	—	—	—	—	—	—	—	—	—	T2CKR<6:0>								0000	
RPINR7	06AE	—	IC2R<6:0>								—	IC1R<6:0>								0000
RPINR8	06B0	—	IC4R<6:0>								—	IC3R<6:0>								0000
RPINR11	06B6	—	—	—	—	—	—	—	—	—	OCFAR<6:0>								0000	
RPINR12	06B8	—	FLT2R<6:0>								—	FLT1R<6:0>								0000
RPINR14	06BC	—	QEB1R<6:0>								—	QEA1R<6:0>								0000
RPINR15	06BE	—	HOME1R<6:0>								—	INDX1R<6:0>								0000
RPINR18	06C4	—	—	—	—	—	—	—	—	—	U1RXR<6:0>								0000	
RPINR19	06C6	—	—	—	—	—	—	—	—	—	U2RXR<6:0>								0000	
RPINR22	06CC	—	SCK2INR<6:0>								—	SDI2R<6:0>								0000
RPINR23	06CE	—	—	—	—	—	—	—	—	—	SS2R<6:0>								0000	
RPINR26	06D4	—	—	—	—	—	—	—	—	—	C1RXR<6:0>								0000	
RPINR37	06EA	—	SYNCI1R<6:0>								—	—	—	—	—	—	—	—	0000	
RPINR38	06EC	—	DTCMP1R<6:0>								—	—	—	—	—	—	—	—	0000	
RPINR39	06EE	—	DTCMP3R<6:0>								—	DTCMP2R<6:0>								0000

**Legend:** — = unimplemented, read as '0'. Reset values are shown in hexadecimal.

#### 4.4.2 EXTENDED X DATA SPACE

The lower portion of the base address space range, between 0x0000 and 0x7FFF, is always accessible regardless of the contents of the Data Space Page registers. It is indirectly addressable through the register indirect instructions. It can be regarded as being located in the default EDS Page 0 (i.e., EDS address range of 0x000000 to 0x007FFF with the base address bit, EA<15> = 0, for this address range). However, Page 0 cannot be accessed through the upper 32 Kbytes, 0x8000 to 0xFFFF, of base Data Space, in combination with DSRPAG = 0x000 or DSWPAG = 0x000. Consequently, DSRPAG and DSWPAG are initialized to 0x001 at Reset.

**Note 1:** DSxPAG should not be used to access Page 0. An EDS access with DSxPAG set to 0x000 will generate an address error trap.

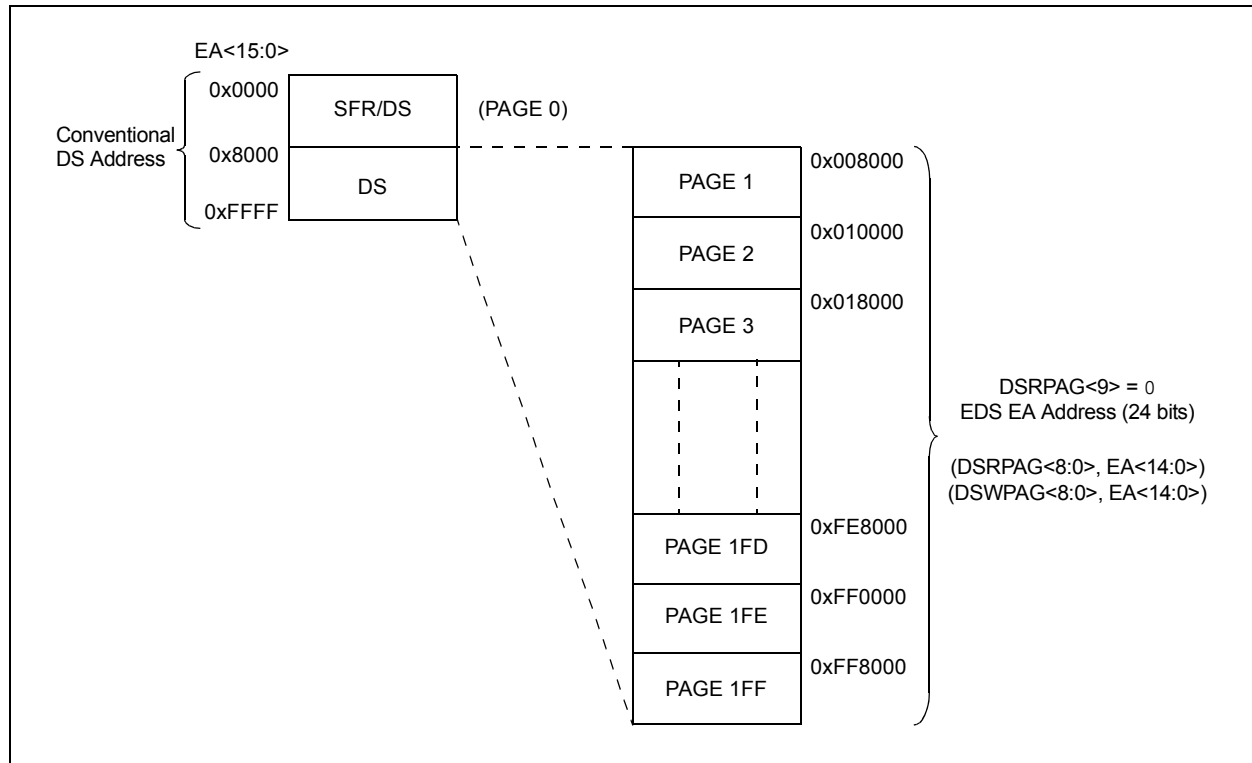
**2:** Clearing the DSxPAG in software has no effect.

The remaining pages, including both EDS and PSV pages, are only accessible using the DSRPAG or DSWPAG registers in combination with the upper 32 Kbytes, 0x8000 to 0xFFFF, of the base address, where base address bit, EA<15> = 1.

For example, when DSRPAG = 0x001 or DSWPAG = 0x001, accesses to the upper 32 Kbytes, 0x8000 to 0xFFFF, of the Data Space will map to the EDS address range of 0x008000 to 0x00FFFF. When DSRPAG = 0x002 or DSWPAG = 0x002, accesses to the upper 32 Kbytes of the Data Space will map to the EDS address range of 0x010000 to 0x017FFF and so on, as shown in the EDS memory map in Figure 4-17.

For more information on the PSV page access using Data Space Page registers, refer to the “**Program Space Visibility from Data Space**” section in “**Program Memory**” (DS70613) of the “*dsPIC33/PIC24 Family Reference Manual*”.

**FIGURE 4-17: EDS MEMORY MAP**



#### 4.8.1 DATA ACCESS FROM PROGRAM MEMORY USING TABLE INSTRUCTIONS

The TBLRDH and TBLWTH instructions offer a direct method of reading or writing the lower word of any address within the Program Space without going through Data Space. The TBLRDH and TBLWTH instructions are the only method to read or write the upper 8 bits of a Program Space word as data.

The PC is incremented by two for each successive 24-bit program word. This allows program memory addresses to directly map to Data Space addresses. Program memory can thus be regarded as two 16-bit-wide word address spaces, residing side by side, each with the same address range. TBLRDH and TBLWTH access the space that contains the least significant data word. TBLRDH and TBLWTH access the space that contains the upper data byte.

Two table instructions are provided to move byte or word-sized (16-bit) data to and from Program Space. Both function as either byte or word operations.

- TBLRDH (Table Read High):
  - In Word mode, this instruction maps the lower word of the Program Space location ( $P<15:0>$ ) to a data address ( $D<15:0>$ )

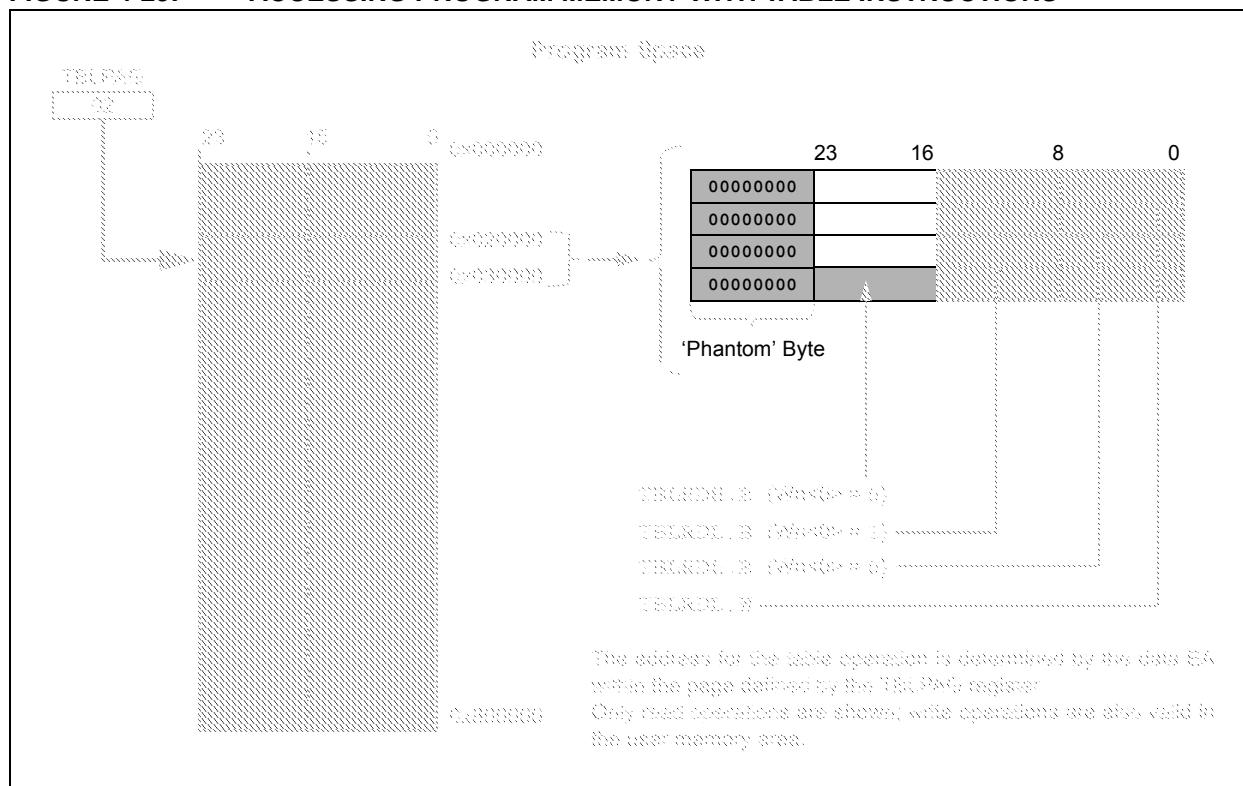
- In Byte mode, either the upper or lower byte of the lower program word is mapped to the lower byte of a data address. The upper byte is selected when Byte Select is '1'; the lower byte is selected when it is '0'.

- TBLRDH (Table Read High):
  - In Word mode, this instruction maps the entire upper word of a program address ( $P<23:16>$ ) to a data address. The 'phantom' byte ( $D<15:8>$ ) is always '0'.
  - In Byte mode, this instruction maps the upper or lower byte of the program word to  $D<7:0>$  of the data address in the TBLRDH instruction. The data is always '0' when the upper 'phantom' byte is selected (Byte Select = 1).

In a similar fashion, two table instructions, TBLWTH and TBLWTL, are used to write individual bytes or words to a Program Space address. The details of their operation are explained in **Section 5.0 "Flash Program Memory"**.

For all table operations, the area of program memory space to be accessed is determined by the Table Page register (TBLPAG). TBLPAG covers the entire program memory space of the device, including user application and configuration spaces. When  $TBLPAG<7> = 0$ , the table page is located in the user memory space. When  $TBLPAG<7> = 1$ , the page is located in configuration space.

**FIGURE 4-23: ACCESSING PROGRAM MEMORY WITH TABLE INSTRUCTIONS**



**REGISTER 8-9: DSADRH: DMA MOST RECENT RAM HIGH ADDRESS REGISTER**

U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0
—	—	—	—	—	—	—	—
bit 15							bit 8

R-0	R-0	R-0	R-0	R-0	R-0	R-0	R-0
DSADR<23:16>							
bit 7							bit 0

**Legend:**

R = Readable bit

W = Writable bit

U = Unimplemented bit, read as '0'

-n = Value at POR

'1' = Bit is set

'0' = Bit is cleared

x = Bit is unknown

bit 15-8 **Unimplemented:** Read as '0'

bit 7-0 **DSADR<23:16>:** Most Recent DMA Address Accessed by DMA bits

**REGISTER 8-10: DSADRL: DMA MOST RECENT RAM LOW ADDRESS REGISTER**

R-0	R-0	R-0	R-0	R-0	R-0	R-0	R-0
DSADR<15:8>							
bit 15							bit 8

R-0	R-0	R-0	R-0	R-0	R-0	R-0	R-0
DSADR<7:0>							
bit 7							bit 0

**Legend:**

R = Readable bit

W = Writable bit

U = Unimplemented bit, read as '0'

-n = Value at POR

'1' = Bit is set

'0' = Bit is cleared

x = Bit is unknown

bit 15-0 **DSADR<15:0>:** Most Recent DMA Address Accessed by DMA bits



**REGISTER 8-13: DMALCA: DMA LAST CHANNEL ACTIVE STATUS REGISTER**

U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0
—	—	—	—	—	—	—	—
bit 15				bit 8			

U-0	U-0	U-0	U-0	R-1	R-1	R-1	R-1
—	—	—	—	LSTCH<3:0>			
bit 7				bit 0			

**Legend:**

R = Readable bit

W = Writable bit

U = Unimplemented bit, read as '0'

-n = Value at POR

'1' = Bit is set

'0' = Bit is cleared

x = Bit is unknown

bit 15-4

**Unimplemented:** Read as '0'

bit 3-0

**LSTCH<3:0>:** Last DMAC Channel Active Status bits

1111 = No DMA transfer has occurred since system Reset

1110 = Reserved

•

•

•

0100 = Reserved

0011 = Last data transfer was handled by Channel 3

0010 = Last data transfer was handled by Channel 2

0001 = Last data transfer was handled by Channel 1

0000 = Last data transfer was handled by Channel 0

### 10.3 Doze Mode

The preferred strategies for reducing power consumption are changing clock speed and invoking one of the power-saving modes. In some circumstances, this cannot be practical. For example, it may be necessary for an application to maintain uninterrupted synchronous communication, even while it is doing nothing else. Reducing system clock speed can introduce communication errors, while using a power-saving mode can stop communications completely.

Doze mode is a simple and effective alternative method to reduce power consumption while the device is still executing code. In this mode, the system clock continues to operate from the same source and at the same speed. Peripheral modules continue to be clocked at the same speed, while the CPU clock speed is reduced. Synchronization between the two clock domains is maintained, allowing the peripherals to access the SFRs while the CPU executes code at a slower rate.

Doze mode is enabled by setting the DOZEN bit (CLKDIV<11>). The ratio between peripheral and core clock speed is determined by the DOZE<2:0> bits (CLKDIV<14:12>). There are eight possible configurations, from 1:1 to 1:128, with 1:1 being the default setting.

Programs can use Doze mode to selectively reduce power consumption in event-driven applications. This allows clock-sensitive functions, such as synchronous communications, to continue without interruption while the CPU idles, waiting for something to invoke an interrupt routine. An automatic return to full-speed CPU operation on interrupts can be enabled by setting the ROI bit (CLKDIV<15>). By default, interrupt events have no effect on Doze mode operation.

For example, suppose the device is operating at 20 MIPS and the ECAN™ module has been configured for 500 kbps, based on this device operating speed. If the device is placed in Doze mode with a clock frequency ratio of 1:4, the ECAN module continues to communicate at the required bit rate of 500 kbps, but the CPU now starts executing instructions at a frequency of 5 MIPS.

### 10.4 Peripheral Module Disable

The Peripheral Module Disable (PMD) registers provide a method to disable a peripheral module by stopping all clock sources supplied to that module. When a peripheral is disabled using the appropriate PMD control bit, the peripheral is in a minimum power consumption state. The control and status registers associated with the peripheral are also disabled, so writes to those registers do not have effect and read values are invalid.

A peripheral module is enabled only if both the associated bit in the PMD register is cleared and the peripheral is supported by the specific dsPIC® DSC variant. If the peripheral is present in the device, it is enabled in the PMD register by default.

**Note:** If a PMD bit is set, the corresponding module is disabled after a delay of one instruction cycle. Similarly, if a PMD bit is cleared, the corresponding module is enabled after a delay of one instruction cycle (assuming the module control registers are already configured to enable module operation).

### 10.5 Power-Saving Resources

Many useful resources are provided on the main product page of the Microchip web site for the devices listed in this data sheet. This product page, which can be accessed using this link, contains the latest updates and additional information.

**Note:** In the event you are not able to access the product page using the link above, enter this URL in your browser:  
<http://www.microchip.com/wwwproducts/Devices.aspx?dDocName=en555464>

#### 10.5.1 KEY RESOURCES

- **“Watchdog Timer and Power-Saving Modes”** (DS70615) in the *“dsPIC33/PIC24 Family Reference Manual”*
- Code Samples
- Application Notes
- Software Libraries
- Webinars
- All Related *“dsPIC33/PIC24 Family Reference Manual”* Sections
- Development Tools

**REGISTER 11-17: RPINR39: PERIPHERAL PIN SELECT INPUT REGISTER 39  
(dsPIC33EPXXXMC20X/50X AND PIC24EPXXXMC20X DEVICES ONLY)**

U-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
—	DTCMP3R<6:0>						
bit 15							bit 8

U-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
—	DTCMP2R<6:0>						
bit 7							bit 0

**Legend:**

R = Readable bit

W = Writable bit

U = Unimplemented bit, read as '0'

-n = Value at POR

'1' = Bit is set

'0' = Bit is cleared

x = Bit is unknown

bit 15 **Unimplemented:** Read as '0'

bit 14-8 **DTCMP3R<6:0>:** Assign PWM Dead-Time Compensation Input 3 to the Corresponding RPn Pin bits (see Table 11-2 for input pin selection numbers)

1111001 = Input tied to RPI121

.

.

.

0000001 = Input tied to CMP1

0000000 = Input tied to Vss

bit 7 **Unimplemented:** Read as '0'

bit 6-0 **DTCMP2R<6:0>:** Assign PWM Dead-Time Compensation Input 2 to the Corresponding RPn Pin bits (see Table 11-2 for input pin selection numbers)

1111001 = Input tied to RPI121

.

.

.

0000001 = Input tied to CMP1

0000000 = Input tied to Vss

**REGISTER 16-7: PWMCONx: PWMx CONTROL REGISTER**

HS/HC-0	HS/HC-0	HS/HC-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
FLTSTAT <sup>(1)</sup>	CLSTAT <sup>(1)</sup>	TRGSTAT	FLTIEEN	CLIEEN	TRGIEEN	ITB <sup>(2)</sup>	MDCS <sup>(2)</sup>
bit 15						bit 8	

R/W-0	R/W-0	R/W-0	U-0	R/W-0	R/W-0	R/W-0	R/W-0
DTC1	DTC0	DTCP <sup>(3)</sup>	—	MTBS	CAM <sup>(2,4)</sup>	XPRES <sup>(5)</sup>	IUE <sup>(2)</sup>
bit 7						bit 0	

<b>Legend:</b>	HC = Hardware Clearable bit	HS = Hardware Settable bit
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared
		x = Bit is unknown

- bit 15 **FLTSTAT:** Fault Interrupt Status bit<sup>(1)</sup>  
 1 = Fault interrupt is pending  
 0 = No Fault interrupt is pending  
 This bit is cleared by setting FLTIEEN = 0.
- bit 14 **CLSTAT:** Current-Limit Interrupt Status bit<sup>(1)</sup>  
 1 = Current-limit interrupt is pending  
 0 = No current-limit interrupt is pending  
 This bit is cleared by setting CLIEEN = 0.
- bit 13 **TRGSTAT:** Trigger Interrupt Status bit  
 1 = Trigger interrupt is pending  
 0 = No trigger interrupt is pending  
 This bit is cleared by setting TRGIEEN = 0.
- bit 12 **FLTIEEN:** Fault Interrupt Enable bit  
 1 = Fault interrupt is enabled  
 0 = Fault interrupt is disabled and the FLTSTAT bit is cleared
- bit 11 **CLIEEN:** Current-Limit Interrupt Enable bit  
 1 = Current-limit interrupt is enabled  
 0 = Current-limit interrupt is disabled and the CLSTAT bit is cleared
- bit 10 **TRGIEEN:** Trigger Interrupt Enable bit  
 1 = A trigger event generates an interrupt request  
 0 = Trigger event interrupts are disabled and the TRGSTAT bit is cleared
- bit 9 **ITB:** Independent Time Base Mode bit<sup>(2)</sup>  
 1 = PHASEx register provides time base period for this PWM generator  
 0 = PTPER register provides timing for this PWM generator
- bit 8 **MDCS:** Master Duty Cycle Register Select bit<sup>(2)</sup>  
 1 = MDC register provides duty cycle information for this PWM generator  
 0 = PDCx register provides duty cycle information for this PWM generator

- Note 1:** Software must clear the interrupt status here and in the corresponding IFSx bit in the interrupt controller.
- 2:** These bits should not be changed after the PWMx is enabled (PTEN = 1).
- 3:** DTC<1:0> = 11 for DTCP to be effective; otherwise, DTCP is ignored.
- 4:** The Independent Time Base (ITB = 1) mode must be enabled to use Center-Aligned mode. If ITB = 0, the CAM bit is ignored.
- 5:** To operate in External Period Reset mode, the ITB bit must be '1' and the CLMOD bit in the FCLCONx register must be '0'.

## 19.1 I<sup>2</sup>C Resources

Many useful resources are provided on the main product page of the Microchip web site for the devices listed in this data sheet. This product page, which can be accessed using this link, contains the latest updates and additional information.

<p><b>Note:</b> In the event you are not able to access the product page using the link above, enter this URL in your browser: <a href="http://www.microchip.com/wwwproducts/Devices.aspx?dDocName=en555464">http://www.microchip.com/wwwproducts/Devices.aspx?dDocName=en555464</a></p>
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### 19.1.1 KEY RESOURCES

- **“Inter-Integrated Circuit (I<sup>2</sup>C)”** (DS70330) in the *“dsPIC33/PIC24 Family Reference Manual”*
- Code Samples
- Application Notes
- Software Libraries
- Webinars
- All Related *“dsPIC33/PIC24 Family Reference Manual”* Sections
- Development Tools

**REGISTER 23-1: AD1CON1: ADC1 CONTROL REGISTER 1 (CONTINUED)**

bit 7-5	<p><b>SSRC&lt;2:0&gt;</b>: Sample Trigger Source Select bits</p> <p><u>If SSRCG = 1:</u></p> <p>111 = Reserved</p> <p>110 = PTGO15 primary trigger compare ends sampling and starts conversion<sup>(1)</sup></p> <p>101 = PTGO14 primary trigger compare ends sampling and starts conversion<sup>(1)</sup></p> <p>100 = PTGO13 primary trigger compare ends sampling and starts conversion<sup>(1)</sup></p> <p>011 = PTGO12 primary trigger compare ends sampling and starts conversion<sup>(1)</sup></p> <p>010 = PWM Generator 3 primary trigger compare ends sampling and starts conversion<sup>(2)</sup></p> <p>001 = PWM Generator 2 primary trigger compare ends sampling and starts conversion<sup>(2)</sup></p> <p>000 = PWM Generator 1 primary trigger compare ends sampling and starts conversion<sup>(2)</sup></p> <p><u>If SSRCG = 0:</u></p> <p>111 = Internal counter ends sampling and starts conversion (auto-convert)</p> <p>110 = CTMU ends sampling and starts conversion</p> <p>101 = Reserved</p> <p>100 = Timer5 compare ends sampling and starts conversion</p> <p>011 = PWM primary Special Event Trigger ends sampling and starts conversion<sup>(2)</sup></p> <p>010 = Timer3 compare ends sampling and starts conversion</p> <p>001 = Active transition on the INT0 pin ends sampling and starts conversion</p> <p>000 = Clearing the Sample bit (SAMP) ends sampling and starts conversion (Manual mode)</p>
bit 4	<p><b>SSRCG</b>: Sample Trigger Source Group bit</p> <p>See SSRC&lt;2:0&gt; for details.</p>
bit 3	<p><b>SIMSAM</b>: Simultaneous Sample Select bit (only applicable when CHPS&lt;1:0&gt; = 01 or 1x)</p> <p><u>In 12-bit mode (AD21B = 1), SIMSAM is Unimplemented and is Read as '0':</u></p> <p>1 = Samples CH0, CH1, CH2, CH3 simultaneously (when CHPS&lt;1:0&gt; = 1x); or samples CH0 and CH1 simultaneously (when CHPS&lt;1:0&gt; = 01)</p> <p>0 = Samples multiple channels individually in sequence</p>
bit 2	<p><b>ASAM</b>: ADC1 Sample Auto-Start bit</p> <p>1 = Sampling begins immediately after the last conversion; SAMP bit is auto-set</p> <p>0 = Sampling begins when the SAMP bit is set</p>
bit 1	<p><b>SAMP</b>: ADC1 Sample Enable bit</p> <p>1 = ADC Sample-and-Hold amplifiers are sampling</p> <p>0 = ADC Sample-and-Hold amplifiers are holding</p> <p>If ASAM = 0, software can write '1' to begin sampling. Automatically set by hardware if ASAM = 1. If SSRC&lt;2:0&gt; = 000, software can write '0' to end sampling and start conversion. If SSRC&lt;2:0&gt; ≠ 000, automatically cleared by hardware to end sampling and start conversion.</p>
bit 0	<p><b>DONE</b>: ADC1 Conversion Status bit<sup>(3)</sup></p> <p>1 = ADC conversion cycle has completed</p> <p>0 = ADC conversion has not started or is in progress</p> <p>Automatically set by hardware when the ADC conversion is complete. Software can write '0' to clear the DONE status bit (software is not allowed to write '1'). Clearing this bit does NOT affect any operation in progress. Automatically cleared by hardware at the start of a new conversion.</p>

- Note 1:** See Section 24.0 “Peripheral Trigger Generator (PTG) Module” for information on this selection.
- 2:** This setting is available in dsPIC33EPXXXMC20X/50X and PIC24EPXXXMC20X devices only.
- 3:** Do not clear the DONE bit in software if Auto-Sample is enabled (ASAM = 1).

**REGISTER 23-5: AD1CHS123: ADC1 INPUT CHANNEL 1, 2, 3 SELECT REGISTER**

U-0	U-0	U-0	U-0	U-0	R/W-0	R/W-0	R/W-0
—	—	—	—	—	CH123NB1	CH123NB0	CH123SB
bit 15					bit 8		

U-0	U-0	U-0	U-0	U-0	R/W-0	R/W-0	R/W-0
—	—	—	—	—	CH123NA1	CH123NA0	CH123SA
bit 7					bit 0		

**Legend:**

R = Readable bit                      W = Writable bit                      U = Unimplemented bit, read as '0'  
-n = Value at POR                      '1' = Bit is set                      '0' = Bit is cleared                      x = Bit is unknown

bit 15-11                      **Unimplemented:** Read as '0'

bit 10-9                      **CH123NB<1:0>:** Channel 1, 2, 3 Negative Input Select for Sample MUXB bits  
In 12-bit mode (AD21B = 1), CH123NB is Unimplemented and is Read as '0':

Value	ADC Channel		
	CH1	CH2	CH3
11	AN9	AN10	AN11
10 <sup>(1,2)</sup>	OA3/AN6	AN7	AN8
0x	VREFL	VREFL	VREFL

bit 8                      **CH123SB:** Channel 1, 2, 3 Positive Input Select for Sample MUXB bit

In 12-bit mode (AD21B = 1), CH123SB is Unimplemented and is Read as '0':

Value	ADC Channel		
	CH1	CH2	CH3
1 <sup>(2)</sup>	OA1/AN3	OA2/AN0	OA3/AN6
0 <sup>(1,2)</sup>	OA2/AN0	AN1	AN2

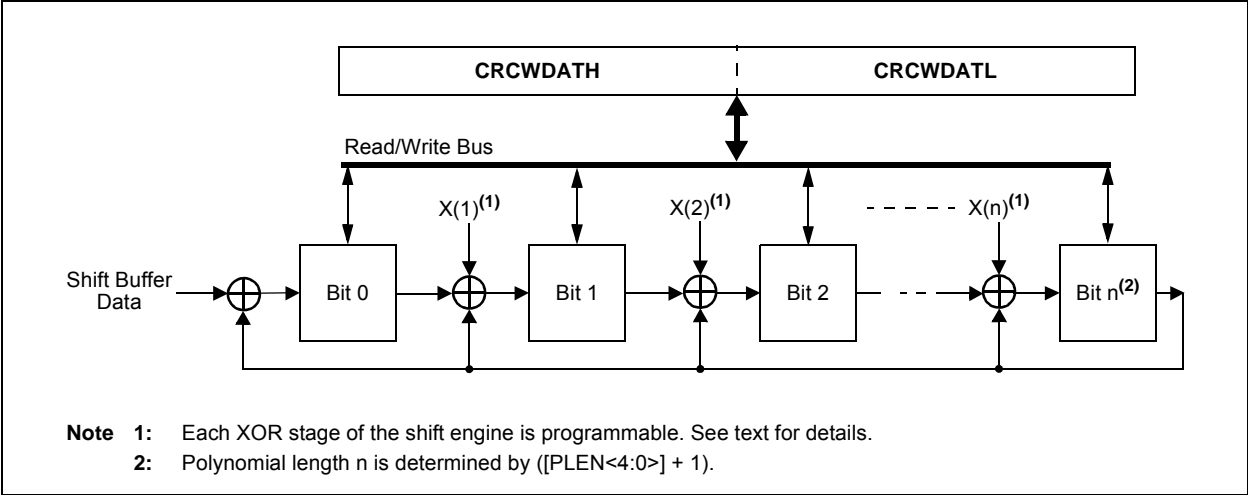
bit 7-3                      **Unimplemented:** Read as '0'

bit 2-1                      **CH123NA<1:0>:** Channel 1, 2, 3 Negative Input Select for Sample MUXA bits  
In 12-bit mode (AD21B = 1), CH123NA is Unimplemented and is Read as '0':

Value	ADC Channel		
	CH1	CH2	CH3
11	AN9	AN10	AN11
10 <sup>(1,2)</sup>	OA3/AN6	AN7	AN8
0x	VREFL	VREFL	VREFL

- Note 1:** AN0 through AN7 are repurposed when comparator and op amp functionality is enabled. See Figure 23-1 to determine how enabling a particular op amp or comparator affects selection choices for Channels 1, 2 and 3.
- 2:** The OAx input is used if the corresponding op amp is selected (OPMODE (CMxCON<10>) = 1); otherwise, the ANx input is used.

FIGURE 26-2: CRC SHIFT ENGINE DETAIL



26.1 Overview

The CRC module can be programmed for CRC polynomials of up to the 32nd order, using up to 32 bits. Polynomial length, which reflects the highest exponent in the equation, is selected by the PLEN<4:0> bits (CRCCON2<4:0>).

The CRCXORL and CRCXORH registers control which exponent terms are included in the equation. Setting a particular bit includes that exponent term in the equation; functionally, this includes an XOR operation on the corresponding bit in the CRC engine. Clearing the bit disables the XOR.

For example, consider two CRC polynomials, one a 16-bit equation and the other a 32-bit equation:

$$x^{16} + x^{12} + x^5 + 1$$

and

$$x^{32} + x^{26} + x^{23} + x^{22} + x^{16} + x^{12} + x^{11} + x^{10} + x^8 + x^7 + x^5 + x^4 + x^2 + x + 1$$

To program these polynomials into the CRC generator, set the register bits as shown in Table 26-1.

Note that the appropriate positions are set to '1' to indicate that they are used in the equation (for example, X26 and X23). The 0 bit required by the equation is always XORed; thus, X0 is a don't care. For a polynomial of length N, it is assumed that the Mth bit will always be used, regardless of the bit setting. Therefore, for a polynomial length of 32, there is no 32nd bit in the CRCXOR register.

TABLE 26-1: CRC SETUP EXAMPLES FOR 16 AND 32-BIT POLYNOMIAL

CRC Control Bits	Bit Values	
	16-bit Polynomial	32-bit Polynomial
PLEN<4:0>	01111	11111
X<31:16>	0000 0000 0000 000x	0000 0100 1100 0001
X<15:0>	0001 0000 0010 000x	0001 1101 1011 011x

26.2 Programmable CRC Resources

Many useful resources are provided on the main product page of the Microchip web site for the devices listed in this data sheet. This product page, which can be accessed using this link, contains the latest updates and additional information.

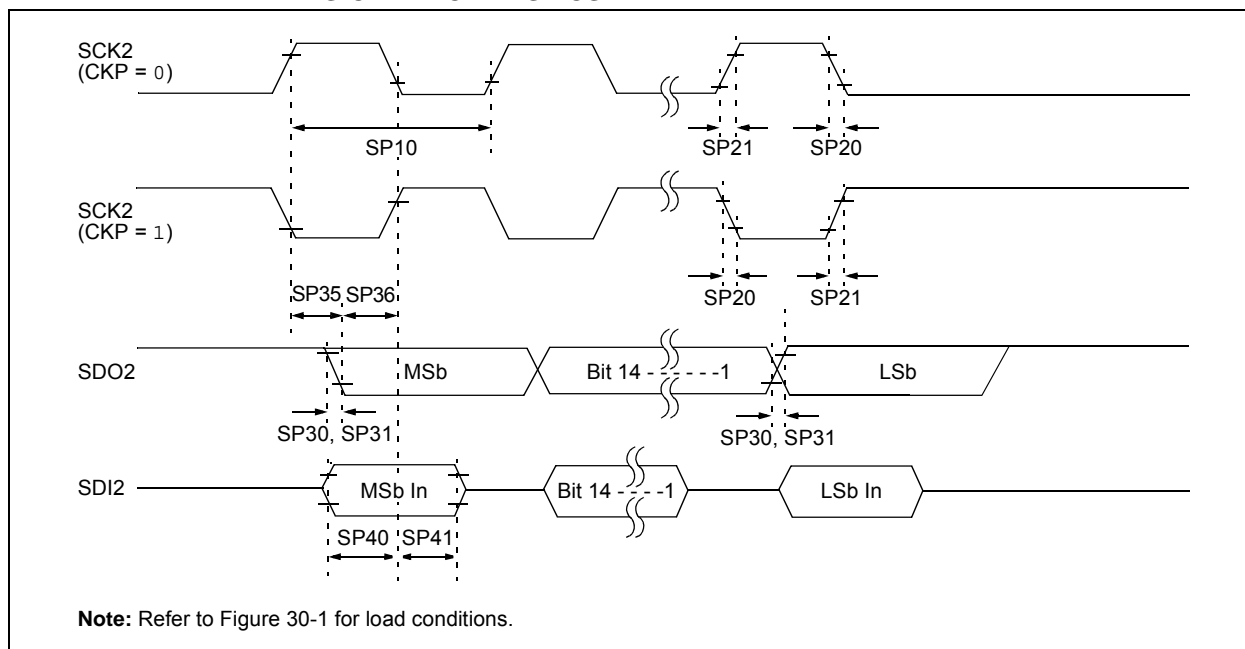
**Note:** In the event you are not able to access the product page using the link above, enter this URL in your browser:  
<http://www.microchip.com/wwwproducts/Devices.aspx?dDocName=en555464>

26.2.1 KEY RESOURCES

- “Programmable Cyclic Redundancy Check (CRC)” (DS70346) in the “dsPIC33/PIC24 Family Reference Manual”
- Code Samples
- Application Notes
- Software Libraries
- Webinars
- All Related “dsPIC33/PIC24 Family Reference Manual” Sections
- Development Tools



**FIGURE 30-17: SPI2 MASTER MODE (FULL-DUPLEX, CKE = 0, CKP = x, SMP = 1)  
TIMING CHARACTERISTICS**



**TABLE 30-36: SPI2 MASTER MODE (FULL-DUPLEX, CKE = 0, CKP = x, SMP = 1)  
TIMING REQUIREMENTS**

AC CHARACTERISTICS			Standard Operating Conditions: 3.0V to 3.6V (unless otherwise stated) Operating temperature -40°C ≤ TA ≤ +85°C for Industrial -40°C ≤ TA ≤ +125°C for Extended				
Param.	Symbol	Characteristic <sup>(1)</sup>	Min.	Typ. <sup>(2)</sup>	Max.	Units	Conditions
SP10	FscP	Maximum SCK2 Frequency	—	—	9	MHz	-40°C to +125°C (Note 3)
SP20	TscF	SCK2 Output Fall Time	—	—	—	ns	See Parameter DO32 (Note 4)
SP21	TscR	SCK2 Output Rise Time	—	—	—	ns	See Parameter DO31 (Note 4)
SP30	TdoF	SDO2 Data Output Fall Time	—	—	—	ns	See Parameter DO32 (Note 4)
SP31	TdoR	SDO2 Data Output Rise Time	—	—	—	ns	See Parameter DO31 (Note 4)
SP35	Tsch2doV, TscL2doV	SDO2 Data Output Valid after SCK2 Edge	—	6	20	ns	
SP36	TdoV2scH, TdoV2scL	SDO2 Data Output Setup to First SCK2 Edge	30	—	—	ns	
SP40	TdiV2scH, TdiV2scL	Setup Time of SDI2 Data Input to SCK2 Edge	30	—	—	ns	
SP41	Tsch2diL, TscL2diL	Hold Time of SDI2 Data Input to SCK2 Edge	30	—	—	ns	

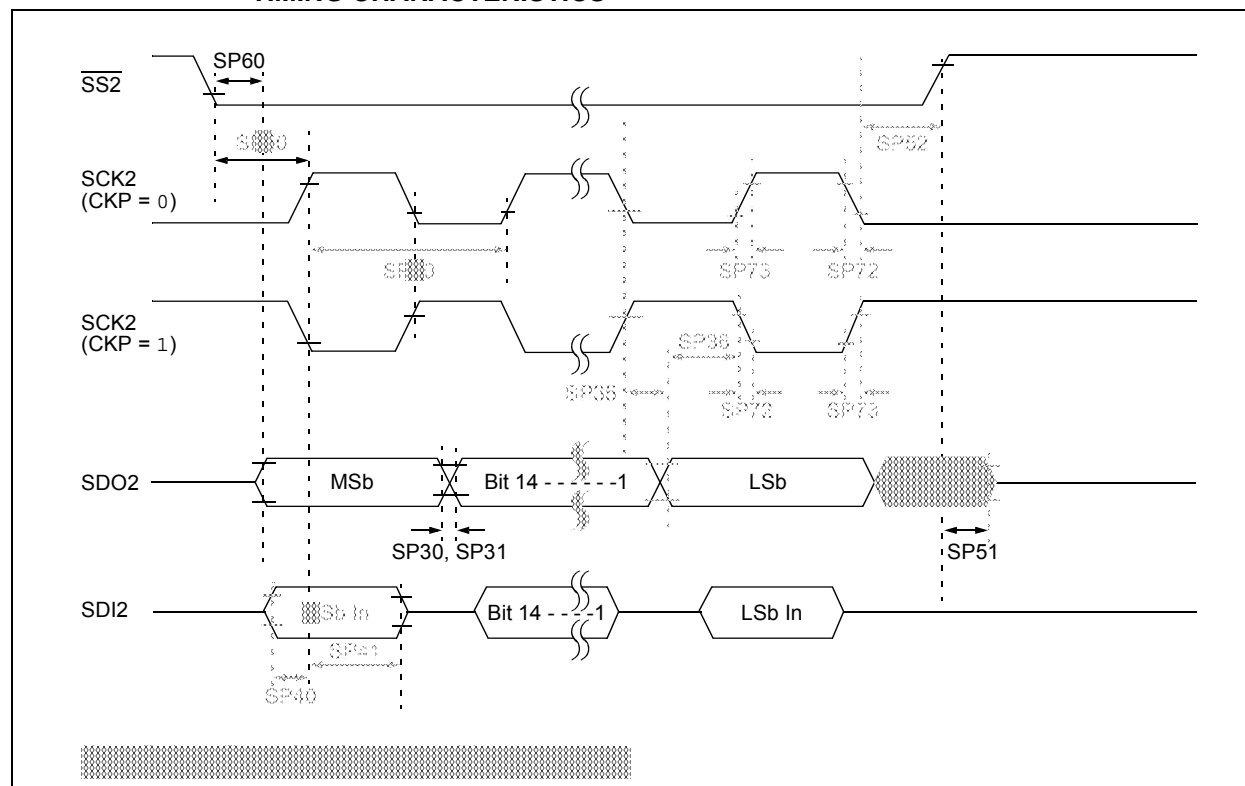
**Note 1:** These parameters are characterized, but are not tested in manufacturing.

**2:** Data in "Typical" column is at 3.3V, +25°C unless otherwise stated.

**3:** The minimum clock period for SCK2 is 111 ns. The clock generated in Master mode must not violate this specification.

**4:** Assumes 50 pF load on all SPI2 pins.

**FIGURE 30-18: SPI2 SLAVE MODE (FULL-DUPLEX, CKE = 1, CKP = 0, SMP = 0)  
TIMING CHARACTERISTICS**



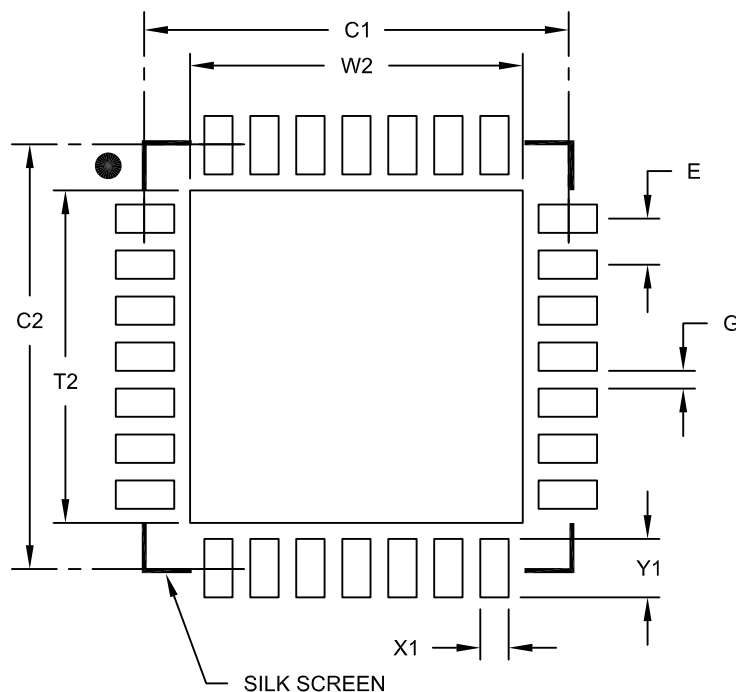
**TABLE 30-48: SPI1 SLAVE MODE (FULL-DUPLEX, CKE = 0, CKP = 0, SMP = 0)  
TIMING REQUIREMENTS**

AC CHARACTERISTICS			Standard Operating Conditions: 3.0V to 3.6V (unless otherwise stated) Operating temperature -40°C ≤ TA ≤ +85°C for Industrial -40°C ≤ TA ≤ +125°C for Extended				
Param.	Symbol	Characteristic <sup>(1)</sup>	Min.	Typ. <sup>(2)</sup>	Max.	Units	Conditions
SP70	FscP	Maximum SCK1 Input Frequency	—	—	11	MHz	(Note 3)
SP72	TscF	SCK1 Input Fall Time	—	—	—	ns	See Parameter DO32 (Note 4)
SP73	TscR	SCK1 Input Rise Time	—	—	—	ns	See Parameter DO31 (Note 4)
SP30	TdoF	SDO1 Data Output Fall Time	—	—	—	ns	See Parameter DO32 (Note 4)
SP31	TdoR	SDO1 Data Output Rise Time	—	—	—	ns	See Parameter DO31 (Note 4)
SP35	Tsch2doV, TscL2doV	SDO1 Data Output Valid after SCK1 Edge	—	6	20	ns	
SP36	TdoV2scH, TdoV2scL	SDO1 Data Output Setup to First SCK1 Edge	30	—	—	ns	
SP40	TdiV2scH, TdiV2scL	Setup Time of SDI1 Data Input to SCK1 Edge	30	—	—	ns	
SP41	Tsch2diL, TscL2diL	Hold Time of SDI1 Data Input to SCK1 Edge	30	—	—	ns	
SP50	TssL2scH, TssL2scL	$\overline{SS1} \downarrow$ to SCK1 $\uparrow$ or SCK1 $\downarrow$ Input	120	—	—	ns	
SP51	TssH2doZ	$\overline{SS1} \uparrow$ to SDO1 Output High-Impedance	10	—	50	ns	(Note 4)
SP52	Tsch2ssH, TscL2ssH	$\overline{SS1} \uparrow$ after SCK1 Edge	1.5 TCY + 40	—	—	ns	(Note 4)

- Note 1:** These parameters are characterized, but are not tested in manufacturing.
- 2:** Data in “Typical” column is at 3.3V, +25°C unless otherwise stated.
- 3:** The minimum clock period for SCK1 is 91 ns. Therefore, the SCK1 clock generated by the master must not violate this specification.
- 4:** Assumes 50 pF load on all SPI1 pins.

**28-Lead Plastic Quad Flat, No Lead Package (MM) – 6x6x0.9 mm Body [QFN-S]  
with 0.40 mm Contact Length**

**Note:** For the most current package drawings, please see the Microchip Packaging Specification located at <http://www.microchip.com/packaging>



**RECOMMENDED LAND PATTERN**

Dimension Limits	Units	MILLIMETERS		
		MIN	NOM	MAX
Contact Pitch	E	0.65 BSC		
Optional Center Pad Width	W2			4.70
Optional Center Pad Length	T2			4.70
Contact Pad Spacing	C1		6.00	
Contact Pad Spacing	C2		6.00	
Contact Pad Width (X28)	X1			0.40
Contact Pad Length (Y28)	Y1			0.85
Distance Between Pads	G	0.25		

**Notes:**

1. Dimensioning and tolerancing per ASME Y14.5M

BSC: Basic Dimension. Theoretically exact value shown without tolerances.

Microchip Technology Drawing No. C04-2124A

DMAxSTAH (DMA Channel x Start Address A, High) .....	144	PTGCST (PTG Control/Status).....	340
DMAxSTAL (DMA Channel x Start Address A, Low) .....	144	PTGHOLD (PTG Hold) .....	347
DMAxSTBH (DMA Channel x Start Address B, High) .....	145	PTGL0 (PTG Literal 0).....	348
DMAxSTBL (DMA Channel x Start Address B, Low) .....	145	PTGQPTR (PTG Step Queue Pointer) .....	349
DSADRH (DMA Most Recent RAM High Address) .....	147	PTGQUEX (PTG Step Queue x) .....	349
DSADRL (DMA Most Recent RAM Low Address) .....	147	PTGSDLIM (PTG Step Delay Limit) .....	346
DTRx (PWMx Dead-Time) .....	238	PTGT0LIM (PTG Timer0 Limit).....	345
FCLCONx (PWMx Fault Current-Limit Control) .....	243	PTGT1LIM (PTG Timer1 Limit).....	345
I2CxCON (I2Cx Control) .....	276	PTPER (PWMx Primary Master Time Base Period).....	233
I2CxMSK (I2Cx Slave Mode Address Mask) .....	280	PWMCONx (PWMx Control).....	235
I2CxSTAT (I2Cx Status) .....	278	QE1CON (QE1 Control) .....	252
ICxCON1 (Input Capture x Control 1) .....	215	QE1GECH (QE1 Greater Than or Equal Compare High Word).....	262
ICxCON2 (Input Capture x Control 2) .....	216	QE1GECL (QE1 Greater Than or Equal Compare Low Word) .....	262
INDX1CNTH (Index Counter 1 High Word) .....	259	QE1ICH (QE1 Initialization/Capture High Word) .....	260
INDX1CNTL (Index Counter 1 Low Word) .....	259	QE1ICL (QE1 Initialization/Capture Low Word) .....	260
INDX1HLD (Index Counter 1 Hold) .....	260	QE1IOC (QE1 I/O Control) .....	254
INT1HLDH (Interval 1 Timer Hold High Word).....	264	QE1LECH (QE1 Less Than or Equal Compare High Word).....	261
INT1HLDL (Interval 1 Timer Hold Low Word) .....	264	QE1LECL (QE1 Less Than or Equal Compare Low Word) .....	261
INT1TMRH (Interval 1 Timer High Word).....	263	QE1STAT (QE1 Status).....	256
INT1TMRL (Interval 1 Timer Low Word).....	263	RCON (Reset Control).....	125
INTCON1 (Interrupt Control 1) .....	134	REFOCON (Reference Oscillator Control) .....	162
INTCON2 (Interrupt Control 2) .....	136	RPINR0 (Peripheral Pin Select Input 0).....	183
INTCON2 (Interrupt Control 3).....	137	RPINR1 (Peripheral Pin Select Input 1).....	184
INTCON4 (Interrupt Control 4) .....	137	RPINR11 (Peripheral Pin Select Input 11).....	187
INTTREG (Interrupt Control and Status).....	138	RPINR12 (Peripheral Pin Select Input 12).....	188
IOCONx (PWMx I/O Control) .....	240	RPINR14 (Peripheral Pin Select Input 14).....	189
LEBCONx (PWMx Leading-Edge Blanking Control) .....	245	RPINR15 (Peripheral Pin Select Input 15).....	190
LEBDLYx (PWMx Leading-Edge Blanking Delay) .....	246	RPINR18 (Peripheral Pin Select Input 18).....	191
MDC (PWMx Master Duty Cycle).....	234	RPINR19 (Peripheral Pin Select Input 19).....	191
NVMADRH (Nonvolatile Memory Address High) .....	122	RPINR22 (Peripheral Pin Select Input 22).....	192
NVMADRL (Nonvolatile Memory Address Low).....	122	RPINR23 (Peripheral Pin Select Input 23).....	193
NVMCON (Nonvolatile Memory (NVM) Control) .....	121	RPINR26 (Peripheral Pin Select Input 26).....	193
NVMKEY (Nonvolatile Memory Key) .....	122	RPINR3 (Peripheral Pin Select Input 3).....	184
OCxCON1 (Output Compare x Control 1) .....	221	RPINR37 (Peripheral Pin Select Input 37).....	194
OCxCON2 (Output Compare x Control 2) .....	223	RPINR38 (Peripheral Pin Select Input 38).....	195
OSCCON (Oscillator Control) .....	156	RPINR39 (Peripheral Pin Select Input 39).....	196
OSCTUN (FRC Oscillator Tuning) .....	161	RPINR7 (Peripheral Pin Select Input 7).....	185
PDCx (PWMx Generator Duty Cycle) .....	237	RPINR8 (Peripheral Pin Select Input 8).....	186
PHASEx (PWMx Primary Phase-Shift) .....	237	RPOR0 (Peripheral Pin Select Output 0).....	197
PLLFBF (PLL Feedback Divisor) .....	160	RPOR1 (Peripheral Pin Select Output 1).....	197
PMD1 (Peripheral Module Disable Control 1) .....	166	RPOR2 (Peripheral Pin Select Output 2).....	198
PMD2 (Peripheral Module Disable Control 2).....	168	RPOR3 (Peripheral Pin Select Output 3).....	198
PMD3 (Peripheral Module Disable Control 3).....	169	RPOR4 (Peripheral Pin Select Output 4).....	199
PMD4 (Peripheral Module Disable Control 4).....	169	RPOR5 (Peripheral Pin Select Output 5).....	199
PMD6 (Peripheral Module Disable Control 6).....	170	RPOR6 (Peripheral Pin Select Output 6).....	200
PMD7 (Peripheral Module Disable Control 7).....	171	RPOR7 (Peripheral Pin Select Output 7).....	200
POS1CNTH (Position Counter 1 High Word) .....	258	RPOR8 (Peripheral Pin Select Output 8).....	201
POS1CNTL (Position Counter1 Low Word) .....	258	RPOR9 (Peripheral Pin Select Output 9).....	201
POS1HLD (Position Counter 1 Hold) .....	258	SEVTCMP (PWMx Primary Special Event Compare) .....	233
PTCON (PWMx Time Base Control).....	230	SPIxCON1 (SPIx Control 1).....	270
PTCON2 (PWMx Primary Master Clock Divider Select 2).....	232	SPIxCON2 (SPIx Control 2).....	272
PTGADJ (PTG Adjust) .....	348	SPIxSTAT (SPIx Status and Control) .....	268
PTGBTE (PTG Broadcast Trigger Enable) .....	343	SR (CPU STATUS).....	40, 132
PTGC0LIM (PTG Counter 0 Limit) .....	346	T1CON (Timer1 Control) .....	205
PTGC1LIM (PTG Counter 1 Limit) .....	347	TRGCONx (PWMx Trigger Control) .....	239
PTGCON (PTG Control) .....	342	TRIGx (PWMx Primary Trigger Compare Value).....	242
		TxCON (Timer2 and Timer4 Control) .....	210